

VSC8541

Single Port Gigabit Ethernet Copper PHY with GMII/RGMII/MII/RMII Interfaces

Low-power, small form-factor Cu PHY with IEEE 802.3az Energy Efficient Ethernet (EEE), Wake-on-LAN (WoL), Synchronous Ethernet (SyncE), Start of Frame (SOF), and Fast Link Failure 2.0 (FLF2) indication, with widest I/O LVCMOS support.

The VSC8541 device, offered in a small 8 mm x 8 mm single-row QFN package, is designed for space-constrained 10/100/1000BASE-T applications. It features integrated line-side termination to conserve board space, lower EMI, and improve system performance. Additionally, integrated RGMII version 2.0 standard timing compliant compensation eliminates the need for on-board delay lines.

The device supports the industry's widest range of LVCMOS levels for a parallel MAC interface including: 1.5 V, 1.8 V, 2.5 V, and 3.3 V, as well as 1.2 V, 1.5 V, 1.8 V, 2.5 V, and 3.3 V support on the MDIO/MDC interface. It includes Microsemi's EcoEthernet[™] 2.0 technology with Energy Efficient Ethernet and power saving features to reduce power based on link state and cable reach. It optimizes power consumption at all link operating speeds, and features Wake-on-LAN power management using magic packets.

The device has a recovered clock output for Synchronous Ethernet applications. Programmable clock squelch control is included to inhibit undesirable clocks from propagating and to help prevent timing loops. Microsemi's patented Ring Resiliency[™] allows a PHY port to switch between master and slave timing references with no link drop while in 1000BASE-T mode.

VSC8541 also includes Fast Link Failure (FLF) indication for highavailability networks. FLF indication identifies the onset of a link failure in less than 1 ms typical, which goes beyond the IEEE 802.3 standard requirement of 750 ms \pm 10 ms (link master). In addition, the device adds a programmable threshold for applications where indication of even a potential link drop must be known at the microsecond level (<10 µs).

Highlights

- EcoEthernet[™] 2.0, with Energy Efficient Ethernet
- Fast Link Failure[™] 2.0 with failure indication for commutator ring applications
- Widest voltage range, fully-compliant parallel MAC interface device
- Start of Frame sync for ingress and egress enables high accuracy calculation of latency (RGMII/RMII mode, VSC8541-03 only)
- Configurable drive strength on MAC interface enables better control of systemlevel EMI/EMC
- Synchronous Ethernet support and Ring Resiliency™

Applications

- IoT applications such as digital signage, eHealth, and industrial grade switches for automation
- Consumer electronics such as CPE, UHDTV, media servers, and NAS
- Wireless backhaul, Hybrid Wi-Fi / LTE-U APs, 4G/5G Small Cells



Microsemi makes no warranty, representation, or guarantee regarding the information contained herein or the suitability of its products and services for any particular purpose, nor does Microsemi assume any liability whatsoever arising out of the application or use of any product or circuit. The products sold hereunder and any other products sold by Microsemi have been subject to limited testing and should not be used in conjunction and together with, or installed in, any end-products. Buyer shall not rely on any data and performance specifications or parameters provided by Microsemi. It is the Buyer's responsibility to independently determine suitability of any products and to test and verify the same. The information provided by Microsemi here user is "and with all faults, and the entire risk associated with such information is entirely with the Buyer. Microsemi described to such information provided by Microsemi here used in conjunction to grant, explicitly or implicitly, to any part rights, licenses, or any other IP rights, whether with regard to such information itself or anything described by such information. Information provided in this document or bany products and services at any time without notice.



VSC8541

Single Port Gigabit Ethernet Copper PHY with GMII/RGMII/MII/RMII Interfaces

Superior PHY and Interface Technology

- 10/100/1000BASE-T Ethernet copper transceiver (IEEE 802.3ab compliant) with Microsemi exclusive non-TDR based VeriPHY[™] cable diagnostics software enables testing without taking down link or impacting data bandwidth while in 1000BASE-T mode
- Patented line driver with low-EMI voltage mode and integrated line-side termination resistors
- WOL support using magic packets
- HP Auto-MDIX and manual MDI/MDIX support
- RGMII/GMII/RMII/MII MAC interface with widest voltage range support in the industry: 1.5 V, 1.8 V, 2.5 V, and 3.3 V (LVCMOS)
- Jumbo frame support up to 16 kilobytes with programmable synchronization FIFOs
- Additional internal FIFO located on ingress side enables support for EtherCAT[®] applications

Synchronous Ethernet Support

- Recovered clock output with programmable clock squelch control and FLF indication (<1 ms typical) for ITU-T G.8261/Y.1361 compliant SyncE applications
- 1000BASE-T Ring Resiliency™ to switch between master and slave timing without dropping link
- Clock output squelch to inhibit clocks during auto-negotiation and no link status

1588v2 PTP System-Level Support (VSC8541-03 only)

• When in RGMII mode, SOF signal (for both ingress and egress) on line side along with synchronized 125 MHz clock enables a high-accuracy time stamping capability when used in conjunction with an appropriate 1588v2 time stamping engine

Best-in-Class Power Consumption

- EcoEthernet[™] 2.0 green energy efficiency with ActiPHY[™], PerfectReach[™], and IEEE 802.3az EEE
- Clause 45 registers to support IEEE 802.3az EEE and IEEE 802.3bf
- Fully optimized power consumption for all link speeds
- 10BASE-Te mode support enables even lower power consumption than 10BASE-T

Key Specifications

- Compliant with IEEE 802.3 (10BASE-T, 10BASE-Te, 100BASE-TX, 1000BASE-T)
- Supports GMII and RGMII (version 1.3), RMII (version 1.2), and MII at 1.5 V, 1.8 V, 2.5 V, and 3.3 V LVCMOS
- RGMII version 2.0 timing compliant
- Supports clocking from 25 MHz crystal or 25/50/125 MHz oscillator
- Microcontroller-free configurability through hardware strapping
- Optionally reports if a link partner is requesting inline Power over Ethernet (PoE and PoE+)
- Optional stand-alone capability supports even the most costsensitive Ethernet enabled designs
- Low alpha mold compound enables 80 SER FIT (VSC8541XMV-03 only)
- Devices support operating temperatures of –40 °C ambient to 125 °C junction or 0 °C ambient to 125 °C junction
- Available in 8 mm x 8 mm, 68-pin single-row QFN package

Related Products

Visit www.microsemi.com for information about these related products:

- VSC8531/VSC8531-03: Single Port Gigabit Ethernet Copper PHY with RGMII/RMII Interface
- VSC8540-03: Single Port Industrial Grade Fast Ethernet Copper PHY with Synchronous Ethernet, GMII/RGMII/MII/RMII Interface
- VSC8530-03: Single Port Industrial Grade Fast Ethernet Copper PHY with RGMII/RMII Interface





Microsemi Corporate Headquarters One Enterprise, Aliso Viejo, CA 92656 USA Within the USA: +1 (800) 713-4113 Outside the USA: +1 (949) 380-6100 Sales: +1 (949) 380-6136 Fax: +1 (949) 380-6136 email: sales.support@microsemi.com www.microsemi.com Microsemi Corporation (Nasdaq: MSCC) offers a comprehensive portfolio of semiconductor and system solutions for communications, defense & security, aerospace and industrial markets. Products include high-performance and radiation-hardened analog mixed-signal integrated circuits, FPGAs, SoCs and ASICs; power management products; timing and synchronization devices and precise time solutions, setting the world's standard for time; voice processing devices; RF solutions; discrete components; enterprise storage and communication solutions, security technologies and scalable anti-tamper products; Ethernet solutions; Power-over-Ethernet ICs and midspans; as well as custom design capabilities and services. Microsemi is headquartered in Aliso Viejo, Calif., and has approximately 4,800 employees globally. Learn more at www.microsemi.com.

©2015–2016 Microsemi Corporation. All rights reserved. Microsemi and the Microsemi logo are registered trademarks of Microsemi Corporation. All other trademarks and service marks are the property of their respective owners.





Общество с ограниченной ответственностью «МосЧип» ИНН 7719860671 / КПП 771901001 Адрес: 105318, г.Москва, ул.Щербаковская д.З, офис 1107

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

http://moschip.ru/get-element

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж: moschip.ru moschip.ru_4

moschip.ru_6 moschip.ru_9